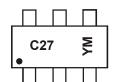


#### **Marking Information**



C27 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key

Year	2009		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	W			J	K	L	М	N	0	Р	R	S
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec

#### Maximum Ratings N-CHANNEL – Q1 (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain Source Voltage		V <sub>DSS</sub>	20	V
Gate-Source Voltage		V <sub>GSS</sub>	±6	V
Drain Current (Note 5)	T <sub>A</sub> = +25°C T <sub>A</sub> = +85°C	ID	1.34 0.97	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	5	А
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		I <sub>SM</sub>	5	А

## Maximum Ratings P-CHANNEL – Q2 (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain Source Voltage		V <sub>DSS</sub>	-20	V
Gate-Source Voltage		V <sub>GSS</sub>	±6	V
Drain Current (Note 5)	T <sub>A</sub> = +25°C T <sub>A</sub> = +85°C	ID	-1.14 -1.07	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	-2.5	A	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		I <sub>SM</sub>	-2.5	А

#### Thermal Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.12	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	111	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Note: 5. For a device mounted on 25mm x 25mm FR-4 PCB board with a high coverage of single sided 1oz copper, in still air conditions with two active die.



## Electrical Characteristics N-CHANNEL – Q1 (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)	· · ·					·
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_		V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>			100	nA	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±1.0	μA	$V_{GS}$ = ±4.5V, $V_{DS}$ = 0V
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.5		1.0	V	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A
Static Drain-Source On-Resistance	P	_	0.3 0.4	0.4 0.5	Ω	$V_{GS} = 4.5V, I_D = 600mA$
	R <sub>DS(on)</sub>	_	0.4	0.5	Ω	$V_{GS}$ = 2.5V, $I_D$ = 500mA $V_{GS}$ = 1.8V, $I_D$ = 350mA
Forward Transfer Admittance	Y <sub>fs</sub>		1.4	_	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 400mA
Diode Forward Voltage (Note 6)	V <sub>SD</sub>	_	0.7	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 150mA
DYNAMIC CHARACTERISTICS						
Input Capacitance	C <sub>iss</sub>		60.67	_	pF	
Output Capacitance	C <sub>oss</sub>	_	9.68		pF	V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	5.37		pF	
Total Gate Charge	Qg		736.6	_		
Gate-Source Charge	Q <sub>gs</sub>	_	93.6		рС	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Drain Charge	Q <sub>gd</sub>	_	116.6		]	I <sub>D</sub> = 250mA
Turn-On Delay Time	t <sub>D(on)</sub>	_	5.1			
Turn-On Rise Time	t <sub>R</sub>		7.4			$V_{DD} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t <sub>D(off)</sub>		26.7		ns	$R_{L} = 47\Omega, R_{G} = 10\Omega,$
Turn-Off Fall Time	tF		12.3			I <sub>D</sub> = 200mA

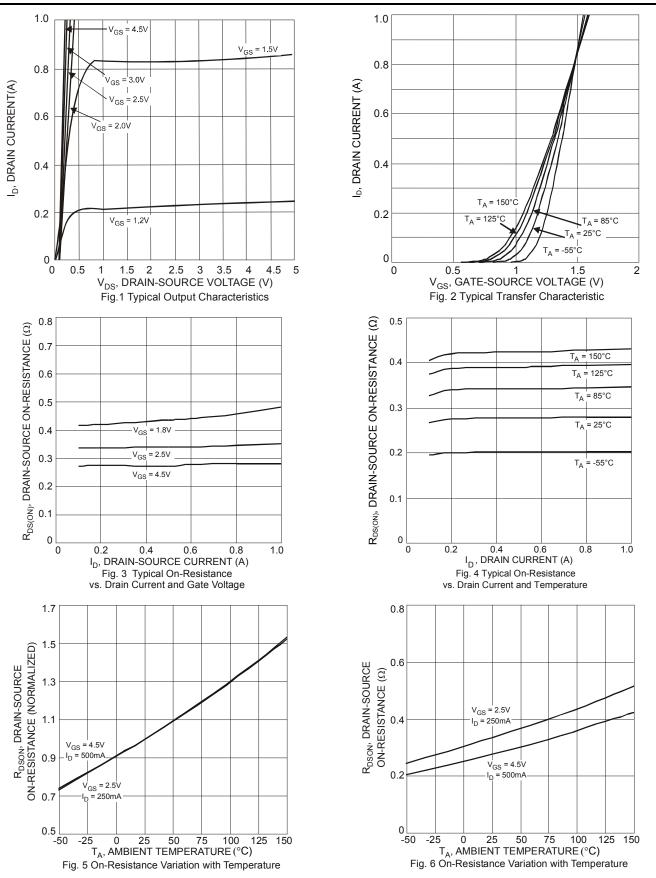
# Electrical Characteristics P-CHANNEL – Q2 (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)				•		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20		_	V	$V_{GS}$ = 0V, $I_{D}$ = -250 $\mu$ A
Zero Gate Voltage Drain Current	IDSS	_	_	-100	nA	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±1.0	μA	$V_{GS}$ = ±4.5V, $V_{DS}$ = 0V
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	-0.5		-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
			0.5	0.7		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -430mA
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>	—	0.7	0.9	Ω	$V_{GS}$ = -2.5V, $I_{D}$ = -300mA
			1.0	1.3		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -150mA
Forward Transfer Admittance	Y <sub>fs</sub>		-0.9		S	V <sub>DS</sub> = -10V, I <sub>D</sub> = -250mA
Diode Forward Voltage (Note 6)	V <sub>SD</sub>	_	-0.8	-1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -150mA
DYNAMIC CHARACTERISTICS						
Input Capacitance	C <sub>iss</sub>	_	59.76	_	pF	
Output Capacitance	C <sub>oss</sub>	_	12.07	_	pF	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V - f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	6.36	_	pF	
Total Gate Charge	Qg		622.4	_		
Gate-Source Charge	Q <sub>gs</sub>	_	100.3	_	рС	V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -10V, I <sub>D</sub> = -250mA
Gate-Drain Charge	Q <sub>gd</sub>	_	132.2	_		ID = -20011A
Turn-On Delay Time	t <sub>D(on)</sub>	_	5.1			
Turn-On Rise Time	t <sub>R</sub>		8.1			$V_{DD} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t <sub>D(off)</sub>		28.4		ns	$R_L = 47\Omega, R_G = 10\Omega,$
Turn-Off Fall Time	t <sub>F</sub>	_	20.7		I <sub>D</sub> = -200mA	

Note: 6. Short duration pulse test used to minimize self-heating effect.



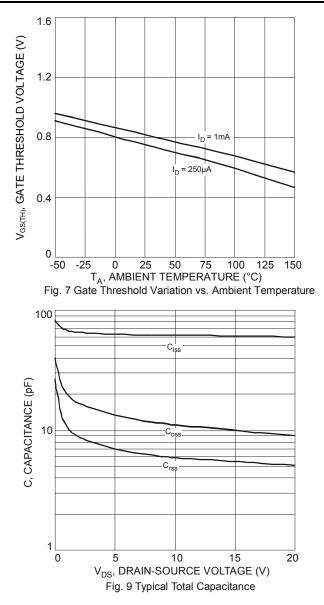
#### N-CHANNEL - Q1

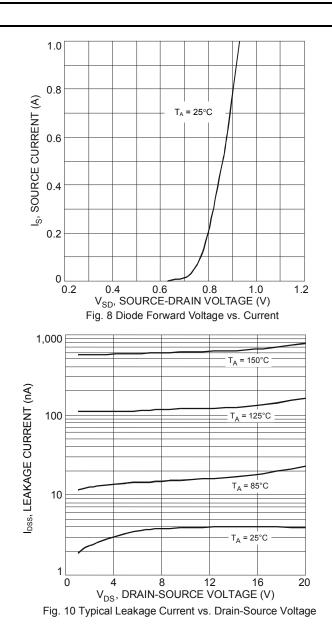


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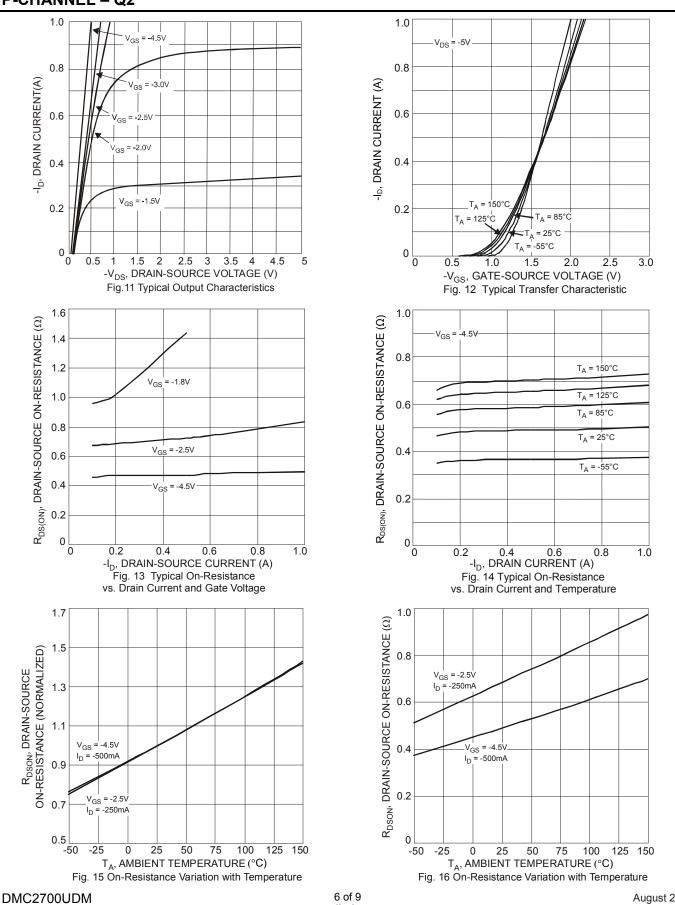
## N-CHANNEL - Q1 (continued)







#### P-CHANNEL – Q2



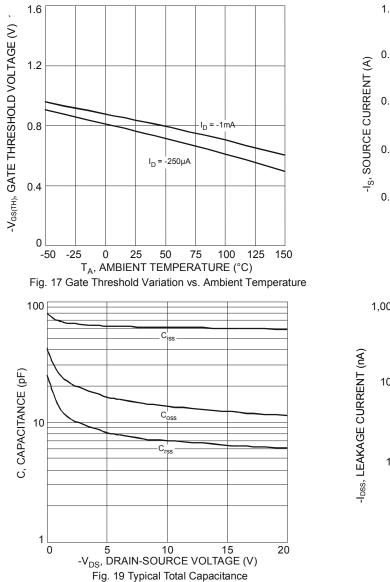
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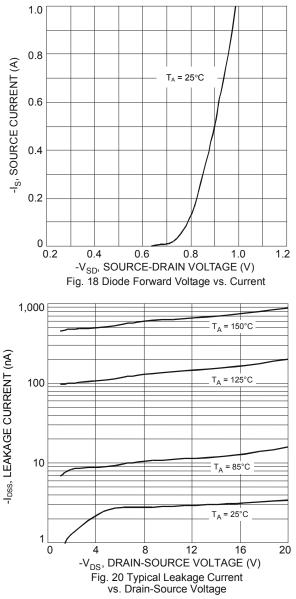
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## P-CHANNEL – Q2 (continued)

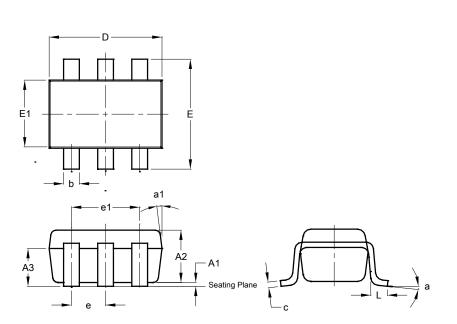






### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



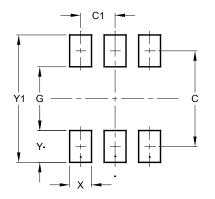
	SOT26						
Dim	Min	Max	Тур				
A1	0.013	0.10	0.05				
A2	1.00	1.30	1.10				
A3	0.70	0.80	0.75				
b	0.35	0.50	0.38				
С	0.10	0.20	0.15				
D	2.90	3.10	3.00				
е	-	-	0.95				
e1	-	-	1.90				
Е	2.70	3.00	2.80				
E1	1.50	1.70	1.60				
L	0.35	0.55	0.40				
а	-	-	8°				
a1	-	-	7°				
All	Dimen	sions	in mm				

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT26

SOT26



Dimensions	Value (in mm)
С	2.40
C1	0.95
G	1.60
Х	0.55
Y	0.80
Y1	3.20



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